MOSFET – Power, Single N-Channel 40 V, 0.45 mΩ, 558 A

NTMTS0D4N04C

Features

- Small Footprint (8x8 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- Power 88 Package, Industry Standard
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
40 V	0.45 mΩ @ 10 V	558 A	

D (5-8) Ç

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	40	V
Gate-to-Source Voltage	Gate-to-Source Voltage			±20	V
Continuous Drain	Steady State	T _C = 25°C	I _D	558	Α
Current R _{θJC} (Notes 1, 3)		T _C = 100°C		394.8	
Power Dissipation		T _C = 25°C	PD	244.0	W
R _{θJC} (Note 1)		T _C = 100°C		122.0	
Continuous Drain	Steady State	$T_A = 25^{\circ}C$	I _D	79.8	А
Current R _{θJA} (Notes 1, 2, 3)		$T_A = 100^{\circ}C$		56.4	
Power Dissipation		$T_A = 25^{\circ}C$	PD	5.0	W
$R_{\theta JA}$ (Notes 1, 2)		T _A = 100°C		2.5	
Pulsed Drain Current	T _A = 25	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		900	А
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to + 175	°C
Source Current (Body Diode) Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 70 A)			I _S	203.4	А
			E _{AS}	4454	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

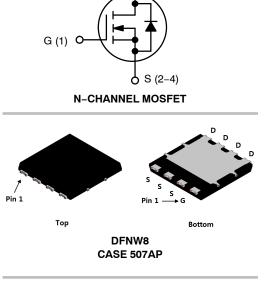
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

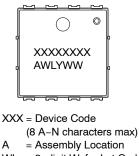
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.61	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	30	

 The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

- 2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- 3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



MARKING DIAGRAM



- WL = 2-digit Wafer Lot Code
- Y = Year Code
- WW = Work Week Code

ORDERING INFORMATION

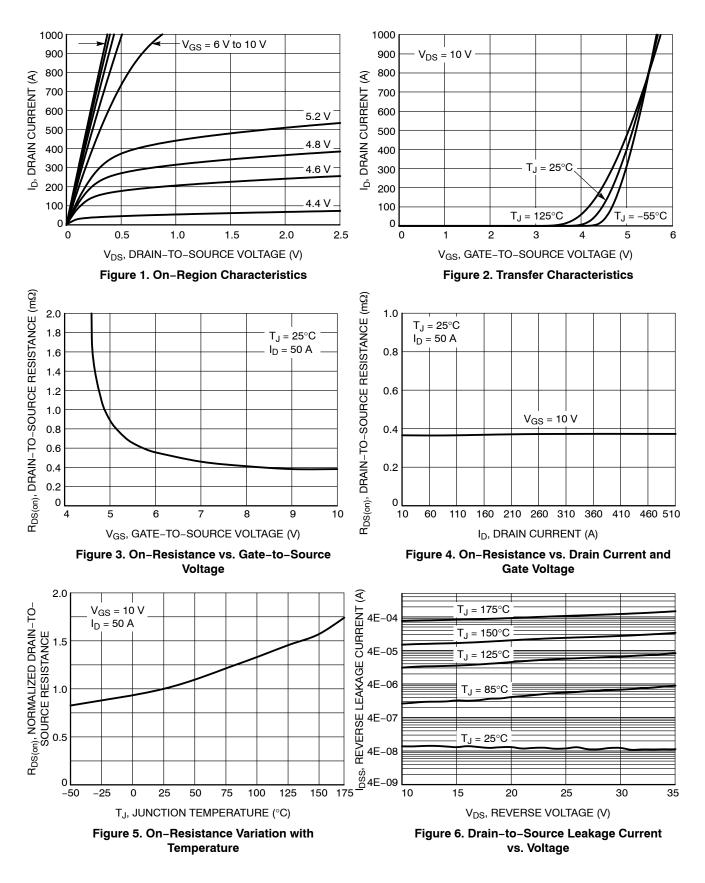
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

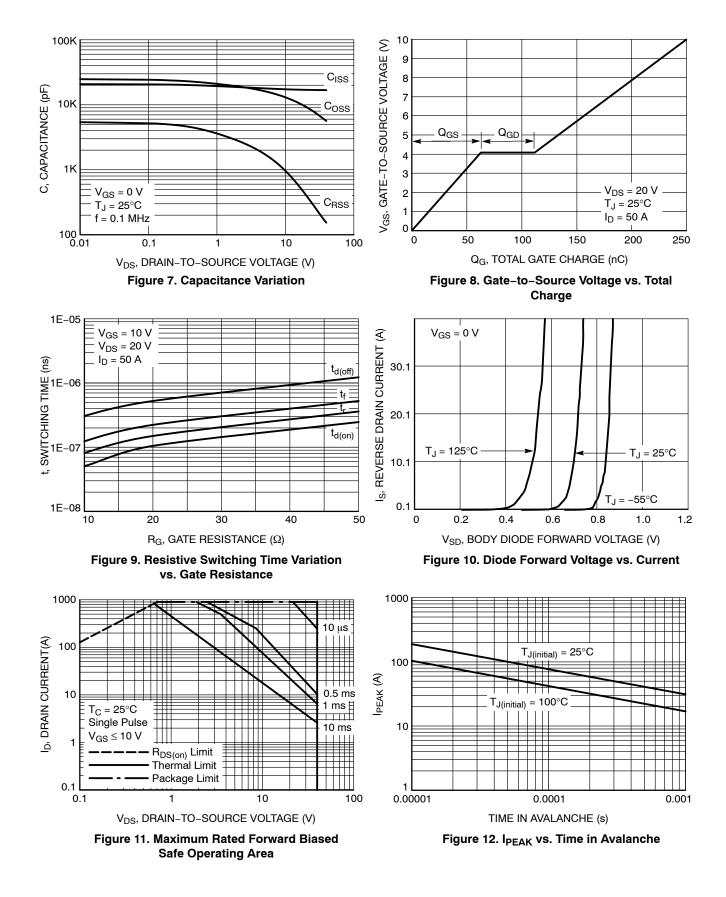
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				7.78		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$, $T_J = 25 °C$				10	
		V _{DS} = 40 V	T _J = 125°C			250	μA
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _G	_{iS} = 20 V			100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 250 μA	2.0		4.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-8.49		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		0.38	0.45	mΩ
Forward Transconductance	9 _{FS}	V _{DS} =15 V, I	_D = 50 A		300		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						
Input Capacitance	C _{ISS}				16500		
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 0.1 M	IHz, V _{DS} = 20 V		8310		pF
Reverse Transfer Capacitance	C _{RSS}				390		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 20 V; I _D = 50 A			251		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 20 V; I _D = 50 A			40.0		
Gate-to-Source Charge	Q _{GS}				62.6		
Gate-to-Drain Charge	Q _{GD}				49.0		
Plateau Voltage	V _{GP}				4.08		V
Gate Resistance	R _G				0.9		Ω
SWITCHING CHARACTERISTICS (Note 5	5)						
Turn-On Delay Time	t _{d(ON)}				55.2		-
Rise Time	t _r	Vcc - 10 V Vr	oo − 20 V		50.8		
Turn-Off Delay Time	t _{d(OFF)}	$\begin{array}{l} V_{GS} = 10 \; V, \; V_{DS} = 20 \; V, \\ I_{D} = 50 \; A, \; R_{G} = 6 \; \Omega \end{array}$			200		ns
Fall Time	t _f				78.7		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V,$ $I_{S} = 50 A$	$T_J = 25^{\circ}C$		0.75	1.2	
			T _J = 125°C		0.58		V
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 50 A			120		ns
Charge Time	t _a				60		
Discharge Time	t _b				60		
Reverse Recovery Charge	Q _{RR}				338		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions, t 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

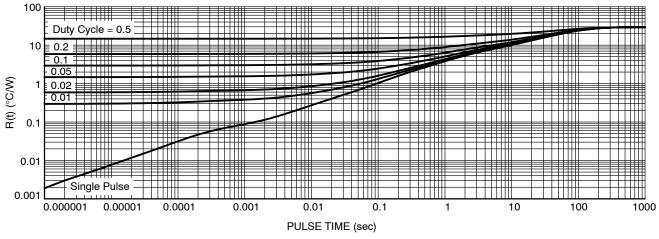


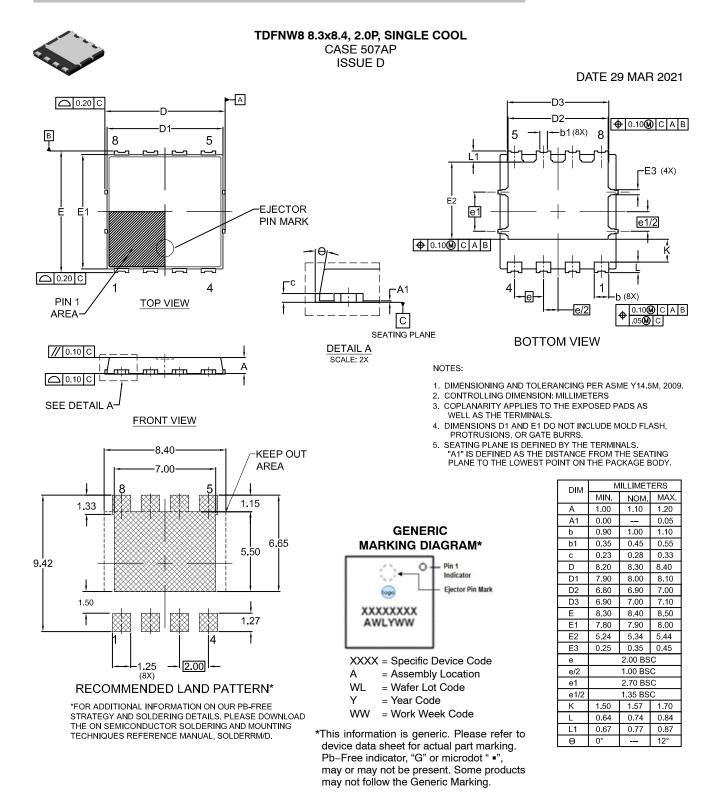
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMTS0D4N04CTXG	0D4N04C	POWER 88 (Pb–Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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